

SMB1N-1900D-02

- Infrared High Power LED
- 1900 nm, 30 mW
- InGaAs chip, 1000 x 1000 µm
- **PA9T SMD package**
- Beam Angle: ± 9°



Description

SMB1N-1900D-02 is a surface mount InGaAsP based high power infrared LED, with a typical peak wavelength of 1900 nm and optical output power of 30 mW @ 1 A. It comes in polyamide resin SMD package (PA9T) with silver plated soldering pads (lead free solderable), copper heat sink, and silicone resin molded lens. Additional variants with different beam angles are available on request.

Maximum Ratings*

Parameter	Symbol	Va	l lmit		
Parameter	Symbol	Min.	Max.	Unit	
Power Dissipation	PD		1600	mW	
Forward Current	IF		1000	mA	
Pulse Forward Current **	IFP		2000	mA	
Reverse Voltage (<i>I_R</i> =10 µA)	UF		2	V	
Thermal Resistance	Rтнја		10	K/W	
Junction Temperature	TJ		120	°C	
Operating Temperature	TCASE	- 40	+ 85	°C	
Storage Temperature	Tstg	- 40	+ 100	°C	
Lead Solder Temperature (t _{max} . 5s)	T _{SLD}		+ 250	°C	

* Operating close to or exceeding these parameters may damage the device

** duty cycle = 1 %, pulse width = 10 μ s

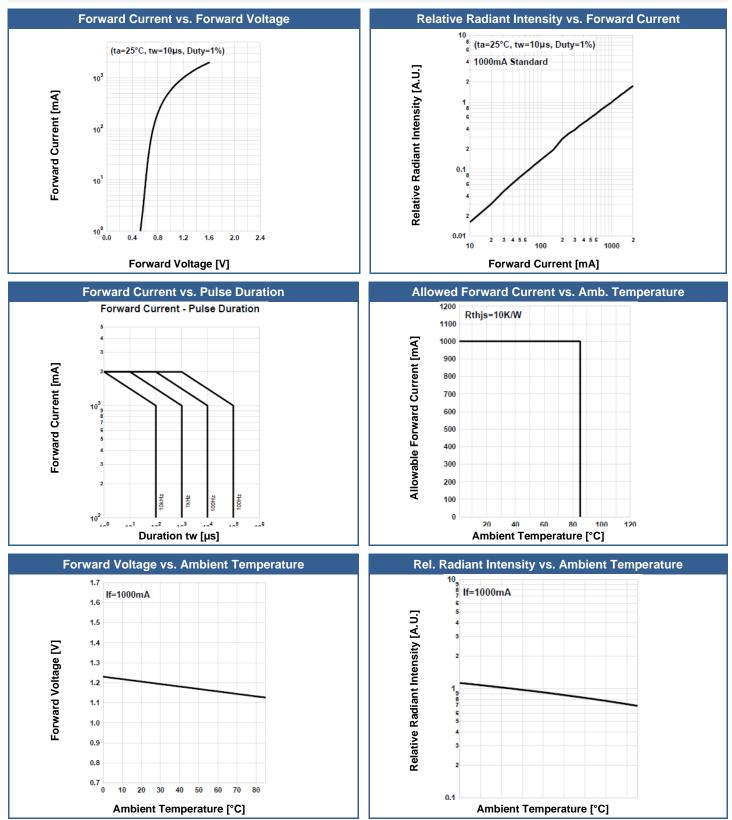
Electro-Optical Characteristics (T_{CASE} = 25°C)

Parameter	Symbol	Conditions	Min.	Values Typ.	Max.	Unit
Peak Wavelength	λP	I⊧=1 A	1850		1950	nm
Half Width	λ_{Δ}	IF=1 A		120		nm
Forward Voltage	UF	IF=1 A		1.2	1.6	V
	UFP	IFP=2 A*		1.6		
Total Radiated Power	Po	I _F =1 A	20	30		mW
		I _{FP} =2 A*		52		
Radiant Intensity	l _E	IF=1 A		t.b.a		mW/sr
		I _{FP} =2 A*		t.b.a		
Viewing Angle	20 1/2	I _F =100 mA		18		deg.
Rise Time	tr	IF=1 A		90		ns
Fall Time	tr	I _F =1 A		30		ns

* duty cycle = 1 %, pulse width = 10 µs

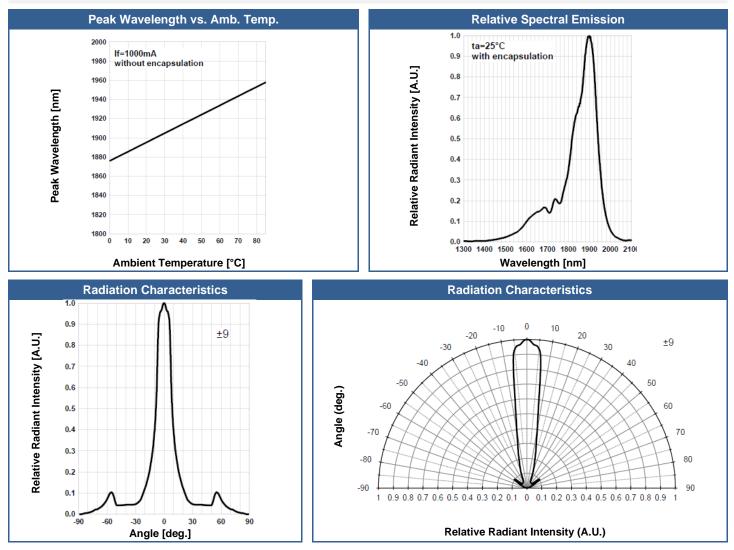


Typical Performance Curves

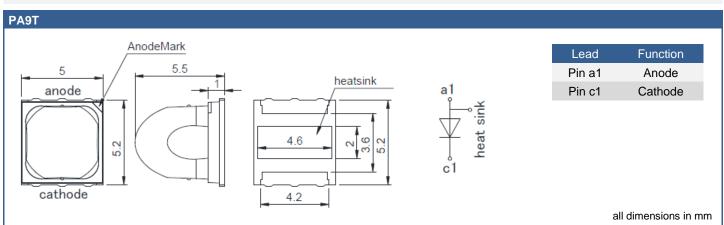




Typical Performance Curves



Outline Dimensions

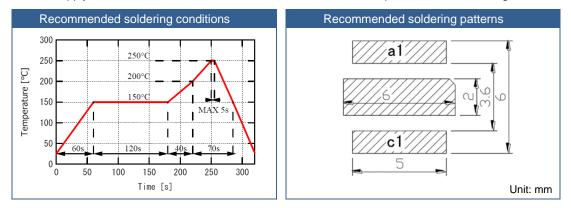




General Notes

Soldering

- Do avoid overheating of the LED
- Do avoid electrostatic discharge (ESD)
- Do avoid mechanical stress, shock, and vibration
- Do only use non-corrosive flux
- · Do not apply current to the LED until it has cooled down to room temperature after soldering



Cleaning

- · Cleaning with isopropyl alcohol, propanol, or ethyl alcohol is recommended
- DO NOT USE acetone, chloroseen, trichloroethylene, or MKS
- DO NOT USE ultrasonic cleaners

Static Electricity

- LEDs are sensitive to electrostatic discharge (ESD).
- · Precautions against ESD must be taken when handling or operating these LEDs
- · Surge voltage or electrostatic discharge can result in complete failure of the LED.

Radiation

- During operation these LEDs do emit light, which could be hazardous to skin and eyes, and may cause cancer.
- Do avoid exposure to the emitted light. Protective glasses if needed
- It is further advised to attach a warning label on products/systems.

Operation

- Do only operate LEDs with a current source.
- Running these LEDs from a voltage source will result in complete failure of the device.
- Current of a LED is an exponential function of the voltage across it. Usage of current regulated drive circuits is mandatory.

Storage

- The maximum shelf life of LEDs in the originally sealed aluminum bag is 12 months.
- Before opening the aluminum bag, please store it at <30 °C, <60 % RH.
- After opening the aluminum bag, please solder the LEDs within 72 hours (floor life) at 5 30 °C, <50 % RH.
- Put any unused, remaining LEDs and silica gel back in the same aluminum bag and then vacuum-seal the bag.
- It is recommended to keep the re-sealed bag in a desiccator at <30%RH.

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The above specifications are for reference purpose only and subjected to change without prior notice